SUPPLEMENT NO. 7 TO PART 748 - AUTHORIZATION VALIDATED END-USER (VEU): LIST OF VALIDATED END-USERS, RESPECTIVE ITEMS ELIGIBLE FOR EXPORT, REEXPORT AND TRANSFER, AND ELIGIBLE DESTINATIONS

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation	
Nothing	Nothing in this Supplement shall be deemed to supersede other provisions in the EAR, including but not limited to § 748				
China (People's Republic of)	Advanced Micro Devices China, Inc.	3D002, 3D003, 3E001 (limited to "technology" for items classified under 3C002 and 3C004 and "technology" for use during the International Technology Roadmap for Semiconductors (ITRS) process for items classified under ECCNs 3B001 and 3B002), 3E002 (limited to "technology" for use during the ITRS process for items classified under ECCNs 3B001 and 3B002), 3E003.e (limited to the "development" and "production" of integrated circuits for commercial applications), 4D001, and 4E001 (limited to the "development" of products under ECCN 4A003).	Advanced Micro Devices (Shanghai) Co., Ltd. Buildings 33 (Unit 1), 46, 47, 48 & 49, River Front Harbor, Zhangjiang Hi-Tech Park, No. 1387 Zhangdong Rd., Pudong, Shanghai, China 201203. AMD Technology Development (Beijing) Co., Ltd. North and South Buildings RaycomInfotech, Park Tower C, No. 2 Science Institute South Rd., Zhong Guan Cun, Haidian District, Beijing, China 100190. AMD Products (China) Co. Ltd. North and South Buildings RaycomInfotech Park Tower C, No. 2 Science Institute South Rd., Zhong Guan Cun, Haidian District, Beijing, China 100190.	75 FR 25763, 5/10/10. 76 FR 2802, 1/18/11. 78 FR 3319, 1/16/13. 81 FR 40783, 6/23/16.	

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation
Nothing	in this Supplemer	nt shall be deemed to supersede other provi	sions in the EAR, including but not limited to §	§ 748.15(c).
	Advanced	2B230, 3B001.a.2, and 3B001.e (items	Advanced Micro-Fabrication Equipment,	78 FR 41291,
	Micro-	classified under ECCNs 3B001.a.2, and	Inc., China	7/10/13.
	Fabrication	3B001.e are limited to components and	188 Taihua Road	80 FR 65931,
	Equipment,	accessories).	Jinqiao Export Processing Zone (South	10/28/15.
	Inc., China		Area)	
			Pudong, Shanghai 201201, China.	
	Applied	These Items Authorized for those	*Applied Materials South East Asia Pte.	72 FR 59164,
	Materials	Applied Materials Destinations	Ltd. Shanghai Depot	10/19/07.
	(China), Inc.	Identified by one asterisk (*):	c/o Shanghai Applied Materials Technical	74 FR 19382,
		2B006.b, 2B230, 2B350.g.3, 2B350.i,	Service Center	4/29/09.
		3B001.a, 3B001.b, 3B001.e, 3B001.f,	No. 2667 Zuchongzhi Road,	75 FR 27185,
		3C001, 3C002, 3D002 (limited to	Shanghai, China 201203.	5/14/10.
		"software" specially designed for the	*Applied Materials South East Asia Pte.	77 FR 10953,
		"use" of stored program controlled	Ltd. Beijing Depot	2/24/12.
		items classified under ECCN 3B001).	c/o Beijing Applied Materials Technical	80 FR 65931,
			Service Center	10/28/15.
			No. 1 North Di Sheng Street, BDA	
			Beijing, China 100176.	
			*Applied Materials South East Asia Pte.	
			Ltd. Wuxi Depot	
			c/o Sinotrans Jiangsu Fuchang Logistics	
			Co., Ltd.	
			1 Xi Qin Road, Wuxi Export Processing	
			Zone	
			Wuxi, Jiangsu, China 214028.	

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation	
Nothing i	Nothing in this Supplement shall be deemed to supersede other provisions in the EAR, including but not limited to § 748				
			*Applied Materials South East Asia Pte.		
			Ltd. Wuhan Depot		
			c/o Wuhan Optics Valley Import & Export		
			Co., Ltd.		
			No. 101 Guanggu Road		
			East Lake High-Tec Development Zone		
			Wuhan, Hubei, China 430074.		
			*Applied Materials (China), Inc.		
			Shanghai Depot		
			No. 2667, Zuchongzhi Road		
			Shanghai, China 201203.		
			*Applied Materials (China), Inc.		
			Beijing Depot		
			No. 1 North Di Sheng Street, BDA		
			Beijing, China 100176.		

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation		
Nothing	Nothing in this Supplement shall be deemed to supersede other provisions in the EAR, including but not limited to § 748.					
		These Items Authorized for the Applied Materials Destination Identified by two asterisks (**): 2B006.b, 2B230, 2B350.g.3, 2B350.i, 3B001.a, 3B001.b, 3B001.e, 3B001.f, 3C001, 3C002, 3D002 (limited to "software" specially designed for the "use" of stored program controlled items classified under ECCN 3B001), and 3E001 (limited to "technology" according to the General Technology Note for the "development" or "production" of items controlled by ECCN 3B001).	**Applied Materials (Xi'an) Ltd. No. 28 Xin Xi Ave., Xi'an High Tech Park Export Processing Zone Xi'an, Shaanxi, China 710075.			
		This item is authorized for the Applied Materials Destination Identified by three asterisks (***): 3E001 (limited to "technology" according to the General Technology Note for the "development" or "production" of items controlled by ECCN 3B001).	*** Applied Materials (China), Inc. – Headquarters 1388 Zhangdong Road, Bldg. 22 Zhangjiang Hi-Tech Park, Pudong Shanghai, 201203, China.			

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation
Nothing	Nothing in this Supplement shall be deemed to supersede other provisions in the EAR, including but not limited to § 7			
rvouning	Boeing Tianjin Composites Co. Ltd.	1B001.f, 1D001 (limited to "software" specially designed or modified for the "use" of equipment controlled by 1B001.f), 2B001.b.2 (limited to machine tools with accuracies no better than (<i>i.e.</i> , not less than) 13 microns), 2D001 (limited to "software," other than that controlled by 2D002, specially designed or modified for the "use" of equipment controlled by 2B001.b.2), and 2D002 (limited to "software" for electronic devices, even when residing in an electronic device or system, enabling such devices or systems to function as a "numerical control" unit, capable of coordinating simultaneously more than 4 axes for "contouring control" controlled by 2B001.b.2).	Boeing Tianjin Composites Co. Ltd., 4566 Heibei Road, Marine Hi-Tech Development Area, Tanggu District, Tianjin, China 300451	72 FR 59164, 10/19/07. 74 FR 19382, 4/29/09. 77FR 10953, 2/24/12. 77 FR 40258, 7/9/12. 81 FR 61104, 9/6/16.
	CSMC Technologies Corporation	1C350.c.3, 1C350.c.11, 2B230.a, 2B230.b, 2B350.f, 2B350.g, 2B350.h, 3B001.e 3B001.h (except for multilayer masks with a phase shift layer designed to produce "space qualified" semiconductor devices), 3C002.a, and 3C004.	CSMC Technologies Fab 1 Co., Ltd. 14 Liangxi Road Wuxi, Jiangsu 214061, China. CSMC Technologies Fab 2 Co., Ltd. 8 Xinzhou Rd. Wuxi National New Hi-Tech Industrial Development Zone Wuxi, Jiangsu 214028, China.	76 FR 2802, 1/18/11. 76 FR 37634, 6/28/11. 77 FR 10953, 2/24/12. 78 FR 23472, 4/19/13. 78 FR 32981, 6/3/13.

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation		
Nothing	Nothing in this Supplement shall be deemed to supersede other provisions in the EAR, including but not limited to § 74					
	Intel	These items authorized for the Intel	*Intel Semiconductor (Dalian) Ltd.	78 FR 54752,		
	Semiconductor	destination identified by one asterisk	No. 109 Huai He Road East	9/6/13.		
	(Dalian) Ltd.	(*):	Dalian Economic and Technology	81 FR 85145,		
		1A004, 1C006.d, 2A226, 2B006.b,	Development Area	11/25/16.		
		2B230, 2B231, 2B350, 3A233.a,	Dalian, Liao Ning Province, 116600			
		3B001 (except for multilayer masks	China			
		with a phase shift layer designed to				
		produce "space qualified"				
		semiconductor devices), 3C002, 3E002				
		(excluding "development" and				
		"production" technology specific to				
		digital signal processors and digital				
		array processors and further limited to				
		"technology" based on the international				
		technology roadmap for				
		semiconductors (ITRS)), and				
		4E001(limited to "technology" for				
		computer products or components not				
		exceeding an adjusted peak				
		performance (APP) level of 12.0				
		weighted teraflops).				

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation		
Nothing	Nothing in this Supplement shall be deemed to supersede other provisions in the EAR, including but not limited to § 74					
		These items authorized for the Intel	** Intel Semiconductor (Dalian) Ltd.			
		destination identified by two asterisks	c/o Dalian Kintetsu Logistics Co., Ltd			
		(**):	Dayaowan Bonded Port No. 6 Road W4			
		1A004, 1C006.d, 2A226, 2B006.b,	Unit A1			
		2B230, 2B231, 2B350, 3A233.a,	Dalian Economic and Technology			
		3B001 (except for multilayer masks	Development Area			
		with a phase shift layer designed to	Dalian, Liao Ning Province, 116601			
		produce "space qualified"	China			
		semiconductor devices), and 3C002.				
	Lam Research	These Items Authorized for those Lam's	*Lam Research International Sarl (Lam	75 FR 62462,		
	Service Co.,	Destinations Identified by a single	Shanghai Warehouse)	10/12/10.		
	Ltd.	asterisk (*):	c/o HMG Supply Chain (Shanghai) Co., Ltd.	77 FR 10953,		
		2B230, 2B350.c, 2B350.d, 2B350.g,	No. 3869, Longdong Avenue	2/24/12.		
		2B350.h, 2B350.i, and 3B001.e (items	Pudong New District	78 FR 3319,		
		classified under ECCN 3B001.e are	Shanghai, China 201203.	1/16/13.		
		limited to "specially designed"	*Lam Research International Sarl (Lam	78 FR 54752,		
		components and accessories), 3D001	Shanghai Warehouse; WGQ Bonded	9/6/13.		
		(limited to "software" (excluding	Warehouse)	79 FR 71014,		
		source code) "specially designed" for	c/o HMG Supply Chain (Shanghai) Co., Ltd.	12/1/14.		
		the "development" or "production" of	No. 55, Fei la Road, Waigaoqiao Free Trade			
		equipment controlled by ECCN	Zone			
		3B001), 3D002 (limited to "software"	Pudong New Area			
		(excluding source code) "specially	Shanghai, China 200131.			

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation
Nothing	in this Supplemen	t shall be deemed to supersede other provi	sions in the EAR, including but not limited to §	748.15(c).
		designed" for the "use" of equipment controlled by ECCN 3B001), and 3E001 (limited to "technology" according to the General Technology Note for the "development" of equipment controlled by ECCN 3B001)	*Lam Research International Sarl (Lam Beijing Warehouse), c/o Beijing Lam Electronics Tech Center, 1 Building, No. 28, Jinghai Second Road, BDA, Beijing, China 100176.	
			*Lam Research International Sarl (Wuxi EPZ Bonded Warehouse) c/o HMG WHL Logistic (Wuxi) Co., Ltd. 1st Fl, Area 4, No. 1, Plot J3 No. 5 Gaolang East Road Export Processing Zone Wuxi, China 214028.	
			*Lam Research International Sarl (Lam Beijing Warehouse) c/o HMG Hi-tech Logistics (Beijing) Co., Ltd. Building 3, No. 9 Ke Chuang Er Street Beijing Economic Technological Development Area Beijing, China 100176.	

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation
Nothing	in this Supplemen	t shall be deemed to supersede other provi	sions in the EAR, including but not limited to §	748.15(c).
			*Lam Research International Sarl (Wuhan TSS) c/o HMG Wuhan Logistic Co., Ltd. 1st-2nd Floor, Area B, No. 5 Building Hua Shi Yuan Er Road East-lake Hi-Tech Development Zone Wuhan, Hubei Province, China 430223.	
			*Lam Research International Sarl (Lam Shanghai Warehouse Operator), c/o Shanghai Well-win Logistics Co., Ltd., No. 2667 Zuchongzhi Road, Pudong New District, Shanghai, China.	
			*Lam Research International Sarl (Lam Beijing Warehouse), c/o China International Electronic Service Company, 1 Building, No. 28, Jinghai Second Road, BDA, Beijing, China 100176.	

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation
Nothing	in this Supplemen	t shall be deemed to supersede other provi	sions in the EAR, including but not limited to §	748.15(c).
			*Lam Research International Sarl (Lam Beijing Warehouse), c/o Beijing STE International Logistics Co., Ltd., Building 3, No. 9 Ke Chuang Er Street, Beijing Economic & Technological Development Area, Beijing, China 100176.	
			*Lam Research International Sarl (Lam Dalian Warehouse), c/o JD Logistics Dalian bonded Logistic Co., Ltd., No. 1 Public Warehouse, Dalian Bonded Logistics Zone, Dalian, China 116600.	
			*Lam Research International Sarl (Lam Xi'an Warehouse), c/o VR International Logistics (Xi'an) Co., Ltd., No. 28 Information Road, EPZ B Zone, Xian New District, Xian, China 710119.	

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation
Nothing	in this Supplemen	t shall be deemed to supersede other provi	sions in the EAR, including but not limited to §	748.15(c).
			*Lam Research International Sarl (Wuxi Bonded Warehouse for CIQ inspection), c/o SinoTrans Jiangsu Fuchang Logistics Co., Ltd., No. 1 Xiqin Road, Area A, Export Processing Zone, New District, Wuxi, China 214028.	
		These Items Authorized for those Lam's Destinations Identified by two asterisks (**): 2B230, 2B350.c, 2B350.d, 2B350.g, 2B350.h, 2B350.i, and 3B001.e (items classified under ECCN 3B001.e are limited to "specially designed" components and accessories), 3D001 (limited to "software" (excluding source code) "specially designed" for the "development" or "production" of equipment controlled by ECCN 3B001), 3D002 (limited to "software" (excluding source code) "specially designed" for the "use" of equipment controlled by ECCN 3B001), and 3E001 (limited to "technology" according to the General Technology Note for the "development" or	**Lam Research Service Co., Ltd. 1st Floor, Area C Hua Hong Science & Technology Park 177 Bi Bo Road Zhangjiang Hi-Tech Park Pudong, Shanghai, China 201203. **Lam Research Service Co., Ltd. Beijing Branch, 6 th Floor, Building 52, No.2, Jingyuan North Street, Beijing Economic & Technological Development Area, Beijing, China 100176. **Lam Research Service Co., Ltd. Wuxi Representative Office Room 302, Building 6, Singapore International Park No. 89 Xing Chuang Si Road Wuxi New District Wuxi, Jiangsu, China 214028.	

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation
Nothing	in this Supplemen	t shall be deemed to supersede other provi	sions in the EAR, including but not limited to §	748.15(c).
		"production" (limited to those stages that support integration, assembly (mounting), inspection, testing, and quality assurance) of equipment controlled by ECCN 3B001).	**Lam Research Service Co., Ltd. Wuhan Representative Office Room 302, Guanggu Software Park Building E4 No. 1 Guanshan Road Donghu Development Zone Wuhan, Hubei Province, China 430074. **Lam Research Service Co., Ltd. (Lam Dalian Representative Office), c/o Intel Semiconductor (Dalian) Ltd., No. 109 Huaihe Road East, Dalian Economic & Technical Development Area, Dalian, China 116600.	
			**Lam Research Service (Shanghai) Co., Ltd. Xi'an Branch, Room 602, Building G, Wangzuo Xiandai City, 35 Tangyan Road, Gaoxin District, Xi'an, China 710065.	

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation
Nothing in this Supplement shall be deemed to supersede other provi			sions in the EAR, including but not limited to §	748.15(c).
	Samsung	1C350.c.3, 1C350.d.7, 2B006.a,	Samsung China Semiconductor Co. Ltd.	78 FR 41291,
	China	2B006.b.1.d, 2B230, 2B350.d.2,	No.1999, North Xiaohe Road	7/10/13.
	Semiconductor	2B350.g.3, 2B350.i.3, 3A233,	Xi'an, China	78 FR 69535,
	Co. Ltd.	3B001.a.1, 3B001.b, 3B001.e, 3B001.f,	710119.	11/20/13.
		3B001.h, 3C002, 3C004, 3D002, and		79 FR 30713,
		3E001 (limited to "technology" for		5/29/14.
		items classified under 3C002 and		80 FR 11863,
		3C004 and "technology" for use		3/5/15.
		consistent with the International		
		Technology Roadmap for		
		Semiconductors process for items		
		classified under ECCNs 3B001 and		
	C1 1 :	3B002).		70 FD 22001
	Shanghai	1C350.c.3, 1C350.d.7, 2B230,	Shanghai Huahong Grace Semiconductor	78 FR 32981,
	Huahong Grace	2B350.d.2, 2B350.g.3, 2B350.i.4,	Manufacturing Corporation – HFab 2	6/3/13.
	Semiconductor	3B001.a.1, 3B001.b, 3B001.e, 3B001.f, 3B001.h, 3C002, 3C004, 5B002, and	668 Guoshoujing Road	
	Manufacturing	5E002 (controlled by ECCNs 5A002,	Zhangjiang Hi-Tech Park Shanghai 201203 China.	
	Corporation	5A004, or 5A992 that have been	Shanghai Huahong Grace Semiconductor	
	Corporation	successfully reviewed under the	Manufacturing Corporation – HFab 1	
		encryption review process specified in	1188 Chuanqiao Road	
		Sections 740.17(b)(2) or 740.17(b)(3)	Pudong, Shanghai 201206 China.	
		of the EAR).	Shanghai Huahong Grace Semiconductor	
			Manufacturing Corporation – GFab1	
			1399 Zuchongzhi Road	
			Zhangjiang Hi-Tech Park	
			Shanghai 201203 China.	

Country	Validated End-User	Eligible Items (By ECCN)	Eligible Destination	Federal Register Citation		
Nothing in this Supplement shall be deemed to supersede other provisions in the EAR, including but not limited to § 748.15(
	SK hynix Semiconductor (China) Ltd.	3B001.a, 3B001.b, 3B001.e, and 3B001.f.	SK hynix Semiconductor (China) Ltd. Lot K7, Wuxi High-tech Zone Comprehensive Bonded Zone Wuxi New District, Jiangsu Province, China 214028.	75 FR 62462, 10/12/10. 77 FR 40258, 7/9/12. 78 FR 3319, 1/16/13. 78 FR 69535, 11/20/13		
	SK hynix Semiconductor (Wuxi) Ltd.	3B001.a, 3B001.b, 3B001.e, and 3B001.f.	SK hynix Semiconductor (Wuxi) Ltd., Lot K7–1, Wuxi High-tech Zone Comprehensive Bonded Zone Wuxi New District, Jiangsu Province, China 214028.	75 FR 62462, 10/12/10. 77 FR 40258, 7/9/12. 78 FR 3319, 1/16/13. 78 FR 69535, 11/20/13		
India	GE India Industrial Pvt Ltd.	1C002.a.1, 1C002.a.2, 1C002.b.1.a, 1C002.b.1.b, 1E001, 2E003.f, 9E003.a.1, 9E003.a.2, 9E003.a.4, 9E003.a.5, 9E003.a.6, 9E003.a.8, and 9E003.c.	GE India Technology Centre Private Limited (GEITC) No. 122, EPIP, Phase II Hoodi Village, Whitefield Road Bangalore 560066, Karnataka, India. Bangalore Engineering Center (BEC) c/o GE India Technology Centre Private Limited (GEITC) No. 122, EPIP, Phase II Hoodi Village, Whitefield Road Bangalore 560066, Karnataka, India.	74 FR 31620, 7/2/09. 74 FR 68147, 12/23/09. 77 FR 10953, 2/24/12.		